

Ex device made of stainless steel, IP66. With installation of the ET 200iSP components (these must be ordered separately). II 2 (1) D Ex tb [ja Da] IIIC T130°C Db. Size (WxHxD): 950x450x230, for max. 24 iSP modules (EM/IM). Cable entries: 2x M32 power supply, 4x M20 bus cables and 110x M16 (5-10 mm) for signals in 5 rows, version in nickel-plated brass. Ambient operating temperature minimum -20 degrees Celsius. The ET 200iSP components to be installed in the enclosure must be ordered with the cabinet.

Further information

Industry Online Support (Manuals, Catalogs, Certificates, FAQ, ...)

<https://support.industry.siemens.com/cs/products?mfn=ps&lc=en-WW>

Industry Mall (Online ordering system)

<https://mall.industry.siemens.com>

